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Stoney formula: Investigation of curvature measurements by optical profilometer

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Abstract. Thin films' residual stress is often determined by the Stoney formula, using the measurements of the substrate curvature, even if the required hypotheses are not completely respected. In this study, a 2.2 μm titanium nitride coating was deposited by reactive sputtering on a silicon substrate. The Stoney formula was used in order to calculate the residual stress of the film. The radius of curvature was measured, before and after coating by optical profilometer, considering the whole surface of the sample. The effect of the substrate shape (square and rectangular) with various dimensions was investigated. We showed that the shape of the substrate influence strongly the deformation. Moreover, it was highlighted that the choice of the radius (maximum value, minimum value, mean value, with or without initial curvature correction) is critical to the determination of the stress.

Introduction

From a qualitatively point of view, thin films' total stress can be written as follow:

$$\sigma_{\text{tot}} = \sigma_{\text{ext}} + \sigma_{\text{th}} + \sigma_{\text{i}} \quad (1)$$

where σ_{ext} represents the external stress due to the external loading, σ_{th} the thermally-induced stress and σ_{i} the internal stress. The thermal component can be estimated using the following equation:

$$\sigma_{\text{th}} = E_f (\alpha_f - \alpha_s) (T_S - T_M) \quad (2)$$

with T_S the coating temperature, T_M the temperature at which the thermal stress are determined, or at which the coating system operates in service, E_f the Young modulus of the film, α_f and α_s the film and the substrate thermal expansion coefficients. In the case of our study σ_{ext} is equal to zero, because no external load is applied. Moreover, in our experimental conditions and using for E_f , α_f and α_s the values reported in the literature [1, 2], we obtain for σ_{th} a negligible value (between 10 and -30 MPa). For these reasons, only the internal stress were considered and evaluated.

The Stoney formula is generally used to calculate the residual stress value [3]:

$$\sigma = \frac{E_s}{6(1-\nu_s)} \frac{h_s^2}{h_f} \left(\frac{1}{R} - \frac{1}{R_0} \right) \quad (3)$$

with E_s the Young's modulus, ν_s the Poisson's ratio and h_s the thickness of the substrate, h_f the thickness of the film, R and R_0 the curvature radii of the substrate after and before deposition.

However, the Stoney formula requires the respect of the following hypotheses [4, 5]:

- the thicknesses of the substrate and the coating are smaller than the lateral dimensions;
- deformations and rotations are infinitesimal;
- the thickness of the coating is smaller than the thickness of the substrate;
- the substrate and the coating are homogenous, isotropic and linear elastic;
- the radius of curvature is equal in all directions (spherical deformation);
- the stress and the radius of curvature are constant on the whole surface of the plate.

Nevertheless, the Stoney formula is frequently used, even if these hypotheses are not completely respected [6].

Concerning the determination of the radius of the curvature, several methods are reported in the literature. For instance, Masters and Salamon [7] and Harper and Wu [8] used punctual curvatures measured in the center and at a quarter of the sample. Ngo et al. [8] showed that the film stress depends on curvatures of the entire substrate and non-locally on the substrate curvature. Consequently, they extended the Stoney formula for non-uniform misfit strain distribution. Another different approach was used by Fillon [9]. The hypothesis of the uniformity of the curvature was assumed, and the stress evolution in the film was monitored in real time during growth, using a multi-beam optical stress sensor technique. The substrate curvature was measured for two orthogonal directions. For each direction, six measurements were realized and the average value was considered.

In the present study a TiN thin film was deposited on silicon substrates with different size and shape on the same time. The substrate curvature was measured, before and after coating, taking into account the whole surface. The residual stress was determined using the Stoney formula adapted to a plate-like substrate (Eq. 3). We showed that the deformation is influenced by the shape of the substrate. Moreover, even if it is well known that the substrate curvature before coating has to be precisely measured, since the substrate flatness is never perfect, the literature never define which radius has to be used for the calculus (maximum, minimum or mean value). In the present work we put in evidence that the choice of the radius is critical for the determination of the stress.

Experimental conditions

A TiN coating was deposited on a 380 μm (001) silicon substrate by dc reactive magnetron sputtering, using a titanium metallic target (purity 99.99 %) in an Ar + N₂ gas mixture. The working pressure was 0.65 Pa and the initial substrate temperature was at 55°C. The discharge potential was 370 V and the substrate was at the floating potential, which was measured during process around 18 V. The Ar and N₂ flow rate were 90 sccm and 40 sccm respectively. In these conditions the growing rate of the TiN film was at the order of 83 nm.min⁻¹. The deposition time was adjusted in order to obtain a film with a constant thickness close to 2.2 μm .

Before the deposition process, the Si substrates are cut from a one side mirror-polished wafer, cleaned in an ultrasonic bath, first with acetone and then ethanol solutions, dried and kept at room temperature. The TiN film was deposited on the mirror-polished surface. In order to investigate the effect of the shape of the substrate on the deformations, five samples were tested with different size and shape, from square (10 x 10 and 15 x 15 mm x mm) to rectangular (10 x 13, 10 x 15, 10 x 19 mm x mm). The curvature radius was measured by an optical profilometer (WYKO NT1100) for both sides of the sample (mirror polished and unpolished) before and after TiN deposition, considering the whole surface of the sample. The values and the directions of the radii of curvature were obtained by Gwyddion¹, which determine the curvature of a surface with two orthogonal directions. The residual stress was then calculated using the modified Stoney formula for a plate-like substrate (Eq. 3).

In this study we will focus only on the results concerning the mirror polished side.

Results and discussion

Influence of the shape of the samples on the deformations.

In the Table 1 are listed the values of the radii of curvature measured for the five samples for two orthogonal directions of the surface (φ_1 and φ_2), before and after coating ($R_{0,1}$, $R_{0,2}$ and R_1 , R_2 respectively):

¹ <http://gwyddion.net/>

Table 1: Radii of curvature measured for the investigated samples.

Sample number	$R_{0,1}$ (m)	$R_{0,2}$ (m)	R_1 (m)	R_2 (m)
1	-47.2	-94.4	67.2	12.7
2	57.5	13.6	10.1	8.1
3	127.7	35.2	17.8	8.4
4	-294.2	39.5	21.9	9.4
5	-32.8	58.8	26.7	10.9

In a first time we chose to neglect the initial curvature correction of the substrate and to consider only the radii measured after coating (R_1 and R_2). For the sample 1 an important difference (about 80 %) can be observed between R_1 and R_2 values, which correspond to an elliptical deformation (Fig. 1a). On the contrary, for the sample 2, the values obtained for R_1 and R_2 suggest that, after coating, the sample tends to a spherical deformed shape (Fig. 1b). The difference between R_1 and R_2 values is nearly 20 %.

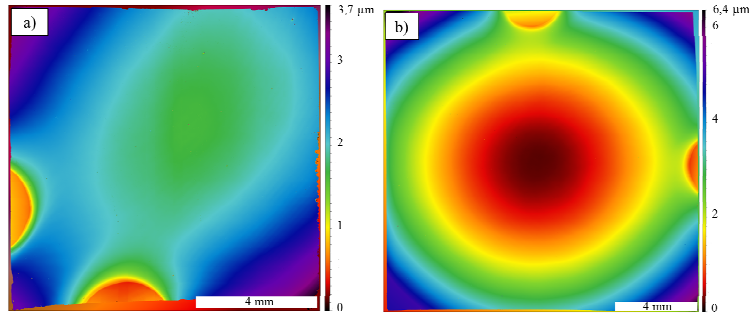


Figure 1: Deformation after coating on sample 1 (a) and 2 (b).

Concerning the rectangular samples (samples 3, 4 and 5), in all cases after coating we observed an elliptical deformation. The difference between R_1 and R_2 values is equal to 53 % for the sample 3, 57 % for the sample 4 and 59 % for the sample 5. These results suggest that the nature of the deformations after coating doesn't depend on the geometry and on the size of the samples.

The results presented in table 1 show clearly that the initial substrate is not flat and that the initial deformation cannot be neglected for the stress calculation. In this aim, we determined $\Delta_1 = \frac{1}{R_1} - \frac{1}{R_{0,1}}$ and $\Delta_2 = \frac{1}{R_2} - \frac{1}{R_{0,2}}$ and we use for convenient the equivalent radii $R_{\text{equivalent}} = \Delta_1^{-1}$ and $R_{2\text{equivalent}} = \Delta_2^{-1}$. The percent of difference between $R_{1\text{eq}}$ and $R_{2\text{eq}}$ is shown in the figure 2, with those between R_1 and R_2 for comparison.

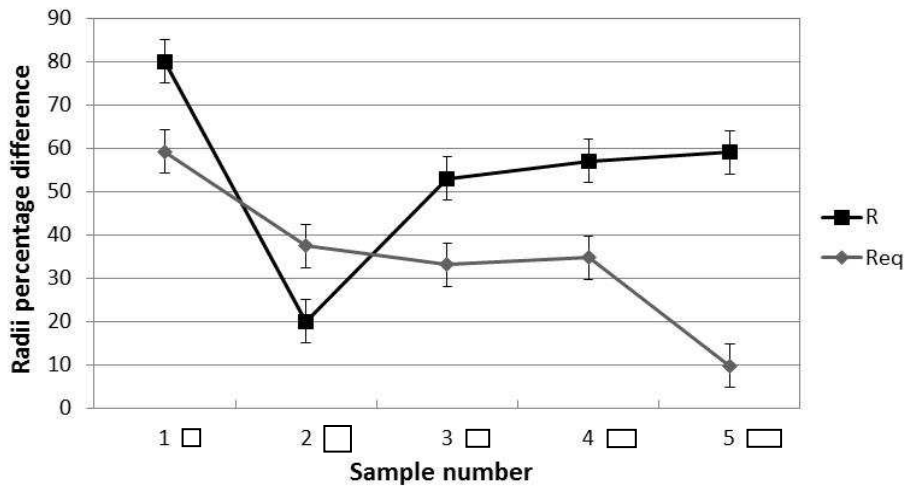


Figure 2: Percentage difference between $R_{\text{eq}1}$ and $R_{\text{eq}2}$ values and R_1 and R_2 values.

If the percentage difference of the radii after coating without initial curvature correction doesn't show any particular trend, it is not the case with this correction. A size effect is detected for square substrate and then a shape effect. This means that for a sufficient size, when the shape of the sample approaches to a strip, the deformation after coating tends to become more spherical. These observations are in agreement with the works of Guyot et al. [8].

Gwyddion allows obtaining not only the values of the curvature radii before and after coating along the principal perpendicular directions of the surface, but also the values of the curvature directions (φ_1 and φ_2). As they are orthogonal, only φ_1 variation is considered. The measured values are shown in the figure 3.

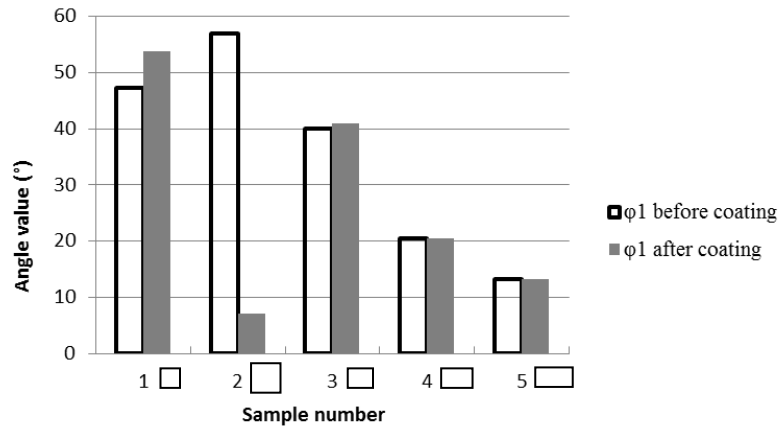


Figure 3: Variation of φ_1 before and after coating. $\varphi_2 = \varphi_1 [\pi/2]$.

The comparison of the results obtained for the five samples shows that, before and after coating, the curvature directions are very similar ($\pm 5^\circ$), with the only exception of the sample 2 (15 x 15 mm), with a difference about 45° . This suggests that the initial orientation of the substrate influence the orientation after coating.

Residual stress values determination.

The residual stress was determined using the modified Stoney formula for a plate-like substrate (Eq. 3). Positive signs of the curvature radii correspond to a concave surface, whereas negative signs to a convex one; mixed signs mean a saddle-like surface. We used the values of 130 GPa for the substrate Young's modulus (E_s) and 0.28 for the substrate Poisson's ratio (ν_s) [10, 11]. The thickness of the substrate (h_s) is given at 386 ± 3.5 by the suppliers and the thicknesses of the films (h_f) were measured by high resolution scanning electron microscopy with a magnification of 25000 and are equal to $2.2 \pm 0.1 \mu\text{m}$. R and R_0 are the curvature radii of the substrate after and before coating and their values are listed in the table 1.

The residual stress was calculated using the final radii R , where the initial curvature of the substrate is neglected, and the equivalent radii R_{eq} , where it is taken into account.

As the radii of curvature were measured along the principal orthogonal directions of the surface, we calculated, for each of the five samples, the maximum, the minimum and the mean value of R and R_{eq} . The highest radii will correspond to a smallest stress, and the smallest radii to the highest stress. The mean value is the most used in the literature. From that, we could calculate three different values of the residual stress for each sample. Of course because we used substrate from the same wafer, and that the coatings were deposited on the same time with a large target (16"x5"), which guarantees a homogeneous deposition zone, we should obtain exactly the same stress in all cases. But, with the radii measurements presented previously, it is clear that there will be differences in the measured stress with the change of substrate shape and the choice of the radii (R or R_{eq}). The results are shown in the figure 4.

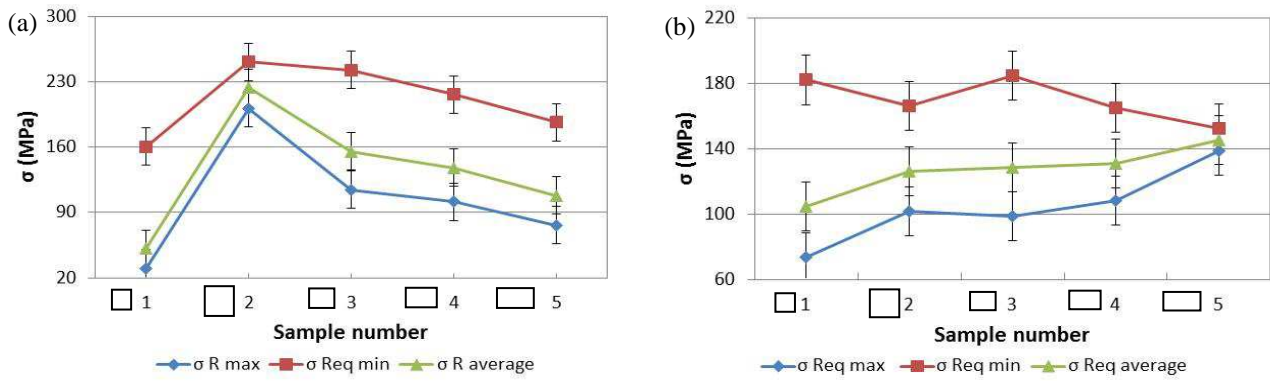


Figure 4: Residual stress calculated using R (a) and R_{eq} (b) values.

These graphs show clearly the importance of the initial curvature. In the case without, the stress takes values from 30 to 250 MPa, and there is no trend with the change of shape of the substrate. In the case with the initial curvature, the stress takes values from 70 to 190 MPa, and there is a clear “shape effect”. More the substrate is strip-like, with probably a minimum size, more the stress is homogeneous and Stoney’s hypothesis validated. Second conclusion, if there were no shape effect, we could assumed a mean value for the five samples and so compare the influence of the choice of the radius used for the stress calculation. The stress calculated in the first case takes values of 105 ± 65 , 135 ± 65 and 210 ± 40 MPa for R_{max} , $R_{average}$ and R_{min} , respectively. In this case, it cannot be determined with precision, as the maximal variation could be around 200 MPa, more or equal to the mean value calculated. In the second case, the stress takes values of 105 ± 25 , 130 ± 15 and 170 ± 15 MPa for $R_{eq_{max}}$, $R_{eq_{average}}$ and $R_{eq_{min}}$, respectively. Here the calculation is more precise, but the maximal variation is about 105 MPa, in the order of the smallest stress mean value. Because of the low stress level it is not so easy to conclude on the choice of the radius. But, even both equivalent radii (min and max) should be used, we could assume that the minimum equivalent radius, corresponding to the highest deformation of the substrate, gives more precise results.

The films studied in this paper present low stress level, in the order of a few hundred of MPa. These results are in agreement with the work of Bielawski [12], who studied the residual stress variation in a TiN/Si coating as a function of the bias voltage and of the deposition pressure. Indeed, in working conditions similar to our experimental parameters, they found tensile residual stress values included between 0 and 200 MPa. Nevertheless, this level is lower than those found by some other authors for TiN films [1, 13, 14, 15]. This difference may be partially explained by different coating conditions (pressure, temperature, bias, etc.), substrate thicknesses and values used for the Young’s modulus and/or the Poisson’s coefficient of the substrate. They (E_s and ν_s) depend on the substrate direction and cover a wide range of values [10, 11]. Another possible explanation may be the presence on the unpolished side of our silicon substrates of high residual stress before coating (293 MPa calculated with the X-ray diffraction technique, using the $\sin^2\psi$ method [16]), when the polished one is at 90 MPa. It might be considered as an external load, and. As a consequence, the initial hypotheses (σ_{ext} equal to zero) should be modified.

Conclusions

The results obtained in our study show that the shape of the substrate before coating has an influence on the deformations after coating. Indeed, it was put in evidence that, when the shape of the sample approaches a strip, the deformation after coating tends to become more spherical. This result is in agreement with the available literature data. Moreover, it was clearly shown that the choice of the curvature radius (maximum, minimum or mean value) is a critical parameter for the determination of the stress. A careful attention should be given to this technique to minimise the dispersion of the calculated stress values and to ensure the relevance of the studies. The stress value is an image of the curvature radius and, as a consequence, of the way it was determined.

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